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LM9074EP

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LM9074EP Enhanced Plastic System Voltage Regulator with Keep-Alive ON/OFF Control

Check for Samples: LM9074EP

FEATURES

- Automotive Application Reliability
- 3% Output Voltage Tolerance
- Insensitive to Radiated RFI
- Dropout Voltage Less Than 2.5V With 180mA **Output Current**
- **Externally Programmed Reset Delay Interval**
- **Keep-Alive Feature With 2 Logic Control** Inputs
- +40V Load Dump Transient Protection
- **Thermal Shutdown**
- Short Circuit Protection and Disable Safety **Features**
- **Reverse Battery Protection**
- Low OFF Quiescent Current, 60µA Maximum

APPLICATIONS

- Selected Military Applications
- **Selected Avionics Applications**

DESCRIPTION

The LM9074EP is a 5V, 3% accurate, 180 mA NPN voltage regulator. The regulator features an active low delayed reset output flag which can be used to reset a microprocessor system on turn-ON and in the event that the regulator output falls out of regulation for any reason. An external capacitor programs a delay time interval before the reset output can return high.

Designed for automotive application the LM9074EP contains a variety of protection features such as reverse battery, over-voltage shutdown, thermal shutdown, input transient protection and a wide operating temperature range.

A unique two-input logic control scheme is used to enable or disable the regulator output. An ON/OFF input can be provided by an ignition switch derived signal while a second, Keep-Alive input, is generated by a system controller. This allows for a system to remain ON after ignition has been switched OFF. The system controller can then execute a power-down routine and after which command the regulator OFF to a low quiescent current state (60 µA max).

Design techniques have been employed to allow the regulator to remain operational and not generate false reset signals when subjected to high levels of RF energy (300V/m from 2 MHz to 400 MHz).

ENHANCED PLASTIC

- Extended Temperature Performance of -40°C to +125°C
- Baseline Control Single Fab & Assembly Site
- Process Change Notification (PCN) ٠
- Qualification & Reliability Data
- Solder (PbSn) Lead Finish is Standard
- Enhanced Diminishing Manufacturing Sources (DMS) Support



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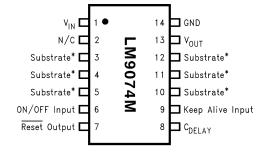
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CONNECTION DIAGRAM



* Substrate pins must be connected to Ground Pin

Figure 1. 14-Pin SOIC Package (Top View) See Package Number D



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾⁽²⁾

Input Voltage	
ON/OFF, Keep-Alive Inputs (through 1 kΩ)	
DC Input Voltage	-26V to +26V
Positive Input Transient (t<100 ms)	40V
Negative Input Transient (t<1 ms)	-50V
Reset Output Sink Current	5 mA
Power Dissipation	Internally Limited
Junction Temperature	150°C
ESD Susceptibility ⁽³⁾	12 kV, 2 kV
Lead Temperature (Soldering, 10 seconds)	260°C
Storage Temperature	−50°C to +150°C

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications and conditions, see the Electrical Characteristics.

(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

(3) All pins will survive an ESD impulse of ±2000V using the human body model of 100 pF discharged through a 1.5 kΩ resistor. In addition, input pins V_{IN} and the ON/OFF input will withstand ten pulses of ±12 kV from a 150 pF capacitor discharged through a 560Ω resistor with each pin bypassed with a 22 nF, 100V capacitor.

OPERATING RATINGS⁽¹⁾

Input Voltage	7.5V to 16.5V
Ambient Temperature	−40°C to +125°C
θja, D Package	88°C/W
θjc, D Package	34°C/W

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications and conditions, see the Electrical Characteristics.

ELECTRICAL CHARACTERISTICS

The following specifications apply for V_{CC}= 7.5V to 16.5V, $-40^{\circ}C \le T_A \le 125^{\circ}C$, unless otherwise specified. C_{OUT}=0.1µF.

Symbol	Parameter	Conditions	Min	Max	Units		
REGULATOR OUTPUT							
V _{OUT}	Output Voltage	20 mA ≤ I _{OUT} ≤ 180 mA	4.85	5.15	V		
ΔV _{OUT} Line Regulation		$I_{OUT} = 20 \text{ mA}, 9V \le V_{IN} \le 16.5V$ $I_{OUT} = 20 \text{ mA}, 7.5V \le V_{IN} \le 16.5V$		25 50	mV mV		
ΔV_{OUT} Load	Load Regulation	$V_{IN} = 14.4V, 20 \text{ mA} \le I_{OUT} \le 180 \text{ mA}$		50	mV		
lq	Quiescent Current	$4V \le V_{ON/OFF} \le V_{IN}$ 20mA $\le I_{OUT} \le 180$ mA		25	mA		
loff	OFF Quiescent Current	V _{IN} ≤ 16.5V, Regulator OFF					
		$-40^{\circ}C \le T_{J} \le 60^{\circ}C$ $60^{\circ}C \le T_{J} \le 135^{\circ}C$		20 60	μA μA		
Vdo	Dropout Voltage	I _{OUT} = 20 mA I _{OUT} = 180 mA		2.0 2.5	V V		
lsc	Short Circuit Current	$R_L = 1\Omega$	0.4	1.0	А		
PSRR	Ripple Rejection	V _{IN} = (14V _{DC}) + (1V _{RMS} @ 120Hz)					
		I _{OUT} = 50 mA	60		dB		
Voth _{OFF}	Safety V _{OUT} Latch-OFF Threshold	In Keep-Alive mode					
		$V_{ON/OFF} = 0V, V_{KA} = 0V$	4	4.5	V		

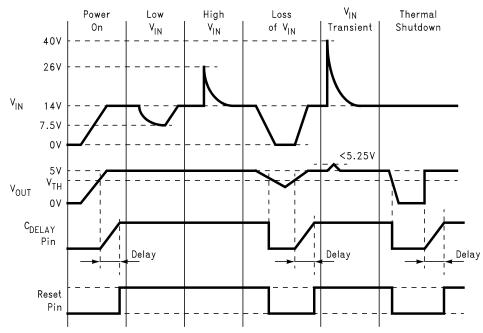


ELECTRICAL CHARACTERISTICS (continued)

The following specifications apply for V_{CC}= 7.5V to 16.5V, $-40^{\circ}C \le T_A \le 125^{\circ}C$, unless otherwise specified. C_{OUT}=0.1µF.

Symbol	Parameter	Conditions	Min	Max	Units
Vo Transient	V _{OUT} during Transients	V _{IN} Peak ≤ 40V, R _L = 100Ω, τ = 100 ms		5.5	V
RESET OUTPL	л	•	•	•	
Vth	Threshold Voltage	ΔV_{OUT} Required to Generate a Reset Output 4.85V ≤ V _{OUT} ≤ 5.15V	-300	-500	mV
Vlow	Reset Output Low Voltage	lsink = 1.6 mA, V _{OUT} > 3.2V		0.4	V
		$1.4V \le V_{OUT} \le 3.2V$		0.8	V
Vhigh Reset Output High Voltage			0.9 V _{OUT}	V _{OUT}	V
t _{delay} Delay Time C		Cdelay = 0.1 µFd	7	45	ms
I _{delay}	Charging Current for Cdelay		-7	25	μA
Rpu	Internal Pull-up Resistance		12	80	kΩ
CONTROL LO	GIC				
V_{KA} low	Low Input Threshold Voltage, Keep-Alive Input	$3.5V \le V_{OUT} \le 5.25V$	0.3 V _{OUT}	0.5 V _{OUT}	V
V_{KA} high	High Input Threshold Voltage, Keep-Alive Input	$3.5V \le V_{OUT} \le 5.25V$	0.6 V _{OUT}	0.8 V _{OUT}	V
$V_{\mbox{ON/OFF}}$ low	Low Input Voltage, ON/OFF Input	Rseries = 1 k Ω	-2	2	V
V _{ON/OFF} high	High Input Voltage, ON/OFF Input	Rseries = 1 k Ω	4	V _{IN}	V
I _{ON/OFF}	Input Current, ON/OFF Input	$V_{ON/OFF} \le 4V$		330	μA
		$4V < V_{ON/OFF} < 7V$		670	μA
		V _{ON/OFF} ≥ 7V		10	mA
Rpu _{KA}	Internal Pull-up Resistance, Keep-Alive Input		20	100	kΩ
Rpd _{ON/OFF}	Internal Pull-down Resistance ON/OFF Input		50	210	kΩ

RESET OPERATION AND PROTECTION FEATURES





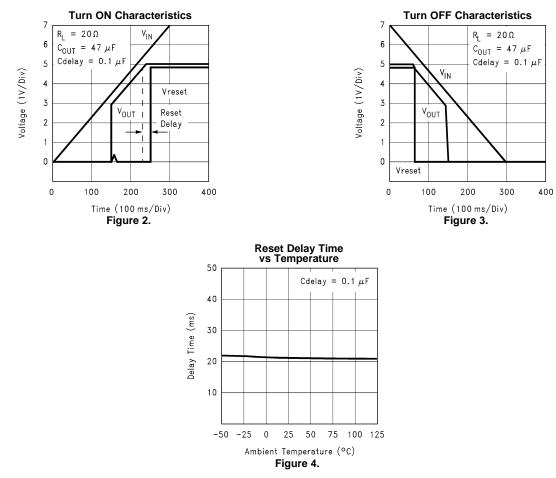


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TYPICAL PERFORMANCE CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless indicated otherwise})$



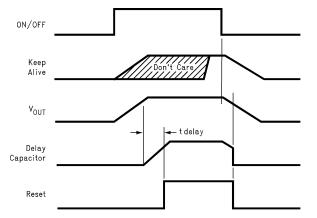


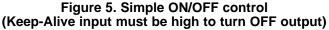
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ON/OFF, KEEP-ALIVE AND SAFETY LATCH-OFF CONTROL DIAGRAMS

Note: If Keep-Alive is provided by a microprocessor powered by the output voltage of the LM9074EP, the logic "1" voltage level will track V_{OUT} as the regulator turns OFF.





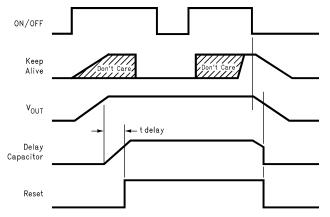


Figure 7. Switch ON with ON/OFF input; Keep output biased with Keep-Alive; Hold ouput ON with ON/OFF; Turn OFF with ON/OFF input. (Temporary Keep-Alive Mode)

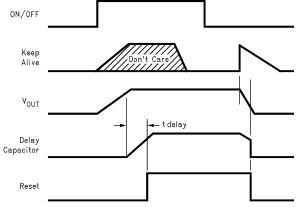


Figure 6. Keep-Alive Mode; Turn ON with ON/OFF control,

Keep output biased with Keep-Alive input, Turn OFF with Keep-Alive (Keep-Alive low keeps output ON, Keep-Alive going high turns output OFF)

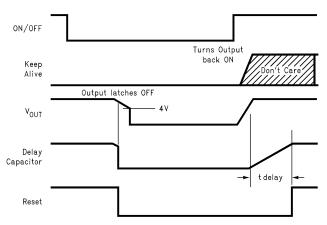


Figure 8. Safety Latch OFF of V_{OUT} when in Keep-Alive Mode (ON/OFF going high required to turn Output back ON)

ON/OFF Input	Keep-Alive Input	Output Voltage	Reset Output	Operating Condition	
L	х	0V	L	Low quiescent current standby (OFF) condition	
1	х	5V	↑ after delay	Output turns ON	
Н	х	5V	Н	Normal ON condition	
Ļ	Н	0V	L	Output turns OFF	
Ļ	L	5V	Н	Output kept ON by Keep-Alive Input	
↑	L	5V	Н	Output remains ON (or turns ON)	
Н	Х	∆V _{OUT} ≥ −300 mV	L	Output pulled out of regulation, reset flag generated	
L	L	$V_{OUT} \le 4V$	L	Output latches OFF	

Control Logic Truth Table



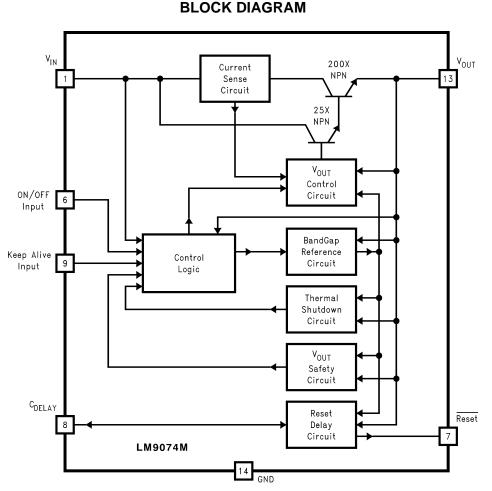


Figure 9. Block Diagram

APPLICATION INFORMATION

The LM9074EP voltage regulator has been optimized for use in microprocessor based automotive systems. Several unique design features have been incorporated to address many FMEA (Failure Mode Effects Analysis) concerns for fail-safe system performance.

FAULT TOLERANT FEATURES

While not specifically ensured due to production testing limitations, the LM9074EP has been tested and shown to continue to provide a regulated output and, not generate an erroneous system reset signal while subjected to high levels of RF electric field energy (up to 300 V/m signal strength over a 2 MHz to 400 MHz frequency range). This is very important in vehicle safety related applications where the system must continue to operate normally. To maintain this immunity to RFI the output bypass capacitor is important (47 µF is recommended).

This regulator is suitable for applications where continuous connection to the battery is required (refer to TYPICAL PERFORMANCE CHARACTERISTICS). ON/OFF control of the regulator and system can be accomplished by switching the ON/OFF input to the battery or ignition supply V_{IN} supply through a SPST switch. If this input becomes open circuited, an internal pull-down resistor ensures that the regulator turns OFF. When the regulator is switched OFF the current load on the battery drops to less than 60 μ A. With the possibility in many applications for V_{IN} and the ON/OFF input pins to be connected in a system through long lengths of wire, the ESD protection of these pins has been increased to 12 kV with the addition of small input bypass capacitors.



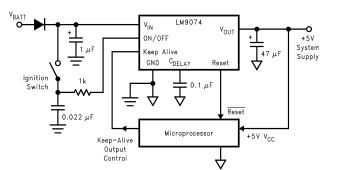


Figure 10. Typical Application Circuit

An output bypass capacitor of at least 0.1μ F is required for stability (47 μ F is recommended). An input capacitor of 1 μ F or larger is recommended to improve line transient and noise performance.

With the Keep-Alive input, a system microprocessor has the ability to keep the regulator ON (with a logic "0" on Keep-Alive) after the ON/OFF input has been commanded OFF. A power-down sequence, when system variables are typically stored in programmable memory, can be executed and take as much time as necessary. At the end of the operation the micro then pulls Keep-Alive high and the regulator and system turn OFF and revert to the low quiescent current standby mode.

For additional system reliability, consideration has been made for the possibility of a short circuited load at the output of the regulator. When the regulator is switched ON, conventional current limiting and thermal shutdown protect the regulator. When the regulator is switched OFF however, a grounded V_{CC} supply to the micro (due to the shorted regulator output) will force the Keep-Alive input to be low and thus try to maintain the Keep-Alive mode of operation. With a shorted load, the drain on the battery could be as high as 1.5A. A separate internal circuit monitors the output voltage of the regulator. If V_{OUT} is less than 4V, as would be the case with a shorted load, the Keep-Alive function is logically disabled to ensure that the regulator turns OFF and reverts to less than a 60 µA load on the battery.

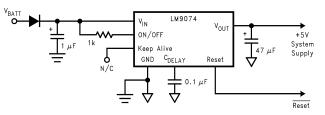


Figure 11. Control Logic Not Used

Conventional load dump protection is built in to withstand up to +60V and -50V transients. A 1 k Ω resistor in series with the ON/OFF and Keep-Alive inputs are recommended to provide the same level of transient protection for these pins if required. Protection against reverse polarity battery connections is also built in. With a reversed battery the output of the LM9074EP will not go more negative than one diode drop below ground. This will prevent damage to any of the 5V load circuits.

For applications where the control logic is not required the logic pins should be configured as shown in Figure 11. A separate device, called the LM9071, can be used. The LM9071 is available in a 5-lead TO-220 package and does not provide control logic functions, but still retains all of the protection features of the LM9074EP.

RESET FLAG

Excessive loading of the output to the point where the output voltage drops by 300 mV to 500 mV will signal a reset flag to the micro. This will warn of a V_{CC} supply that may produce unpredictable operation of the system. On power-up and recovery from a fault condition the delay capacitor is used to hold the micro in a reset condition for a programmable time interval to allow the system operating voltages and

clock to stabilize before executing code. The typical delay time interval can be estimated using the following equation:





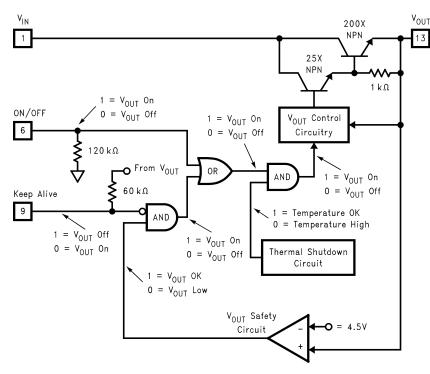


Figure 12.

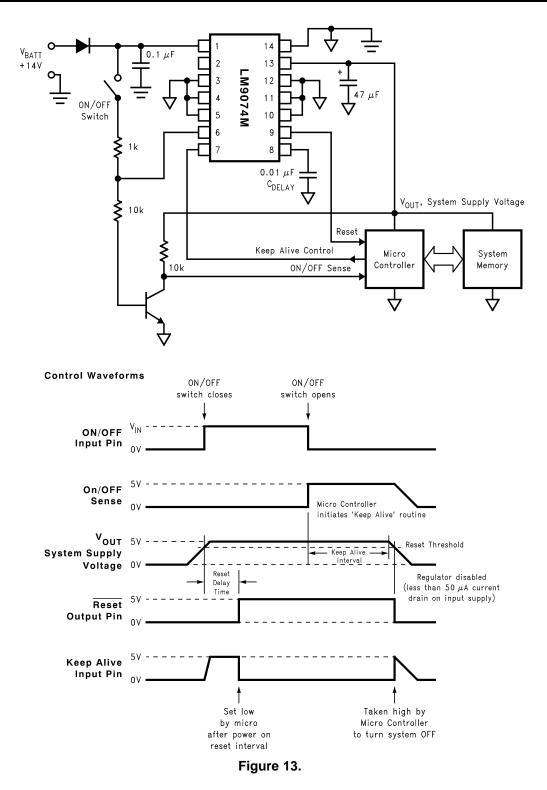
MICROPROCESSOR SYSTEM REGULATOR WITH KEEP-ALIVE INTERVAL AT TURN-OFF

The following circuit illustrates a system application utilizing both of the logic control inputs of the LM9074EP. Closing the ON/OFF switch powers ON the system. Once powered, the system controller sets the Keep-Alive line low. The NPN transistor is used only to signal the controller that the ON/OFF switch has been opened and the system is to be turned OFF. Upon detecting this high level at the ON/OFF Sense input line, the controller can then perform a power down routine. The system will remain fully powered until the controller commands total shut down by taking the Keep-Alive line high. The system then shuts OFF and reverts to a very low current drain standby condition until switched back on.

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Changes from Revision A (April 2013) to Revision B				
•	Changed layout of National Data Sheet to TI format	10		

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